晶采光電科技股份有限公司
AMPIRE CO., LTD.

SPECIFICATIONS FOR LCD MODULE

CUSTOMER	
CUSTOMER PART NO.	
AMPIRE PART NO.	AM-320240NSMZQW-TW0H
APPROVED BY	
DATE	

☐ Preliminary Specification
☑ Formal Specification

AMPIRE CO., LTD.
4F., No.116, Sec. 1, Xintai 5th Rd., Xizhi Dist., New Taipei City221, Taiwan (R.O.C.)
新北市汐止區新台五路一段 **116** 號 **4** 樓(東方科學園區 **A** 棟)
TEL:886-2-26967269 , FAX:886-2-26967196 or 26967270

Approved by	Checked by	Organized by
Kokai	Mark	Lawlite

*This specification is subject to change without notice.

RECORD OF REVISION

Revision Date	Page	Contents	Editor
2024/03/25	-	New Release	Lawlite

1 Features

5.7 inch Amorphous-TFT-LCD (Thin Film Transistor Liquid Crystal Display) module. This module is composed of a 5.7” TFT-LCD panel, LCD controller, and power driver circuit and backlight unit.

1.1 TFT Panel Feature :

(1) Construction: 5.7” a-Si color TFT-LCD, White LED Backlight and PCB.
(2) Resolution (pixel): 320(R.G.B) x 240
(3) Number of the Colors : 262K colors (R , G , B 6 bit digital each)
(4) LCD type : Transmissive Color IPS TFT LCD (normally Black)
(5) Interface: 33 pin pitch 0.5
(6) Power Supply Voltage: 3.3V single power input. Built-in power supply circuit.
(7) Viewing Direction: Direction: All Direction
(8) ROHS compliant

1.2 LCD Controller Feature :

(1) MCU interface 8/9/16/18 bit 80&68 series MCU interface.
(2) Display RAM size : 640x240x3x6 bits. Ex:320x240 two frame buffer with 262K colors.
(3) Arbitrary display memory start position selection.
(4) MCU interface : 16 bit 80 MPU interface.
(5) 8 bit / 16 bit interface support 65K (R5G6B5) / 262K (R6G6B6) colors data format.
(6) 9 bit / 18 bit interface support 262K (R6G6B6) colors data format only.

2 Physical specifications

Item	Specifications	Unit
Display resolution(dot)	960 (W) x 240(H)	mm
Active Area	115.2 (W) x 86.4 (H)	mm
Screen Size	5.7(Diagonal)	mm
Pixel Size	120 (W) x 360 (H)	um
Color Configuration	R.G.B stripe	
Backlight Unit	LED	

3 Default Setting & Option

- Interface :

The user can select the MCU interface by change the Jumper & Resister Array.

Setting / Interface Type	JP1	RA1	RA2	RA3	RA4	Remark
80-18Bit interface	1,2 short 2,3 open	2K ohm	OPEN	OPEN	OPEN	
80-16Bit interface	**1,2 short 2,3 open**	**OPEN**	**2K ohm**	**OPEN**	**OPEN**	**Default**
80-9Bit interface	1,2 short 2,3 open	OPEN	OPEN	2K ohm	OPEN	
80-8Bit interface	1,2 short 2,3 open	OPEN	OPEN	OPEN	2K ohm	
68-18Bit interface	1,2 open 2,3 short	2K ohm	OPEN	OPEN	OPEN	
68-16Bit interface	1,2 open 2,3 short	OPEN	2K ohm	OPEN	OPEN	
68-9Bit interface	1,2 open 2,3 short	OPEN	OPEN	2K ohm	OPEN	
68-8Bit interface	1,2 open 2,3 short	OPEN	OPEN	OPEN	2K ohm	

- Connector

33Pin Pin Header (Pitch 0.5 x 33 pin)		80/68 8/9/**16**/18 bit interface	**Default**

4 Electrical specification

4.1 Absolute max. ratings

4.1.1 Electrical Absolute max. ratings

Item	Symbol	Condition	Min.	Max.	Unit	Remark
Power Voltage	VDD	VSS=0	-0.3	5.5	V	
Input Voltage	VIN		-0.3	VDD+0.3	V	Note 1

Note1: /CS, /WR, /RD, RS, DB0~DB7

4.1.2 Environmental Absolute max. ratings

Item	OPERATING		STORAGE		Remark
	MIN	MAX	MIN	MAX	
Temperature	-20	70	-30	80	Note1,2,3,4,5,6
Humidity	Note1		Note1		
Corrosive Gas	Not Acceptable		Not Acceptable		

Note1 : Ta <= 40℃ : 85% RH max
Ta > 40℃ : Absolute humidity must be lower than the humidity of 85%RH at 40℃

Note2 : For storage condition Ta at -30℃ < 240h, at 80℃ < 240h
For operating condition Ta at -20℃ < 240h, at 70℃ < 240h

Note3 : Background color changes slightly depending on ambient temperature. This phenomenon is reversible.

Note4 : The response time will be slower at low temperature.

Note5 : Only operation is guaranteed at operating temperature. Contrast , response time, another display quality are evaluated at +25℃

Note6 : When LCM be operated over than 40℃ , the life time of the LED back-light will be reduced.

4.2 Electrical characteristics

4.2.1 DC Electrical characteristic of the LCD

Typical operating conditions (VSS=0V)

Item		Symbol	Min.	Typ.	Max.	Unit	Remark
Power Supply		VDD	3.0	3.3	5.0	V	
Input Voltage for logic	H Level	VIH	0.7 VDD	-	VDD	V	Note 1
	L Level	VIL	0	-	0.3 VDD	V	
Power Supply Current		IDD	-	T.B.D.	-	mA	Note 2

Note1: /CS, /WR, /RD, RS, DB0~DB7

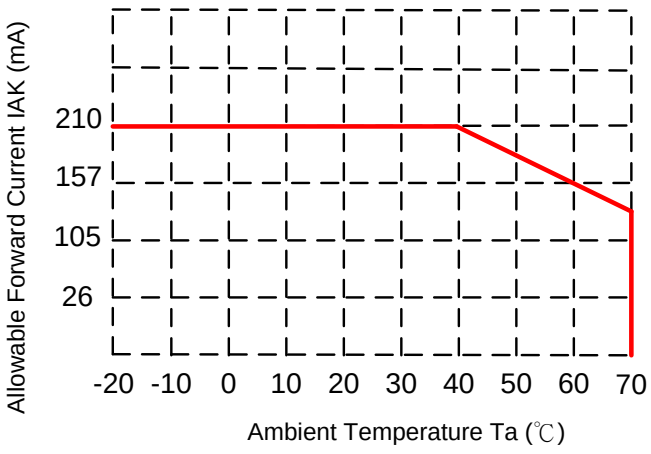
Note2: fv =60Hz , Ta=25℃ , Display pattern : All White

4.2.2 Electrical characteristic of LED Back-light

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
LED Voltage	VAK	8.4	--	10.8	V	IAK =210mA, Ta=25℃
LED Forward Current	IAK	--	210	--	mA	Ta=25℃
Lamp Life Time		--	50,000	--	Hr	IAK =210mA, Ta=25℃

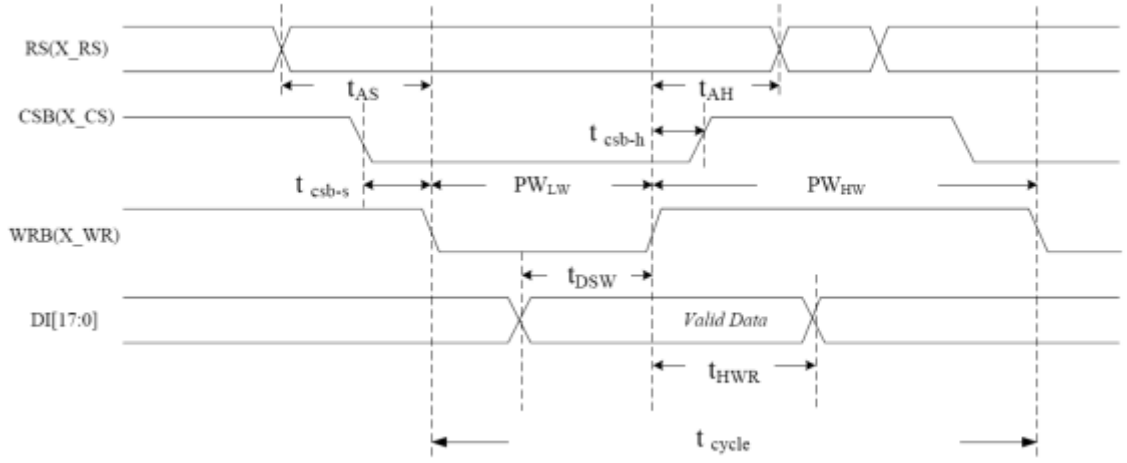
The constant current source is needed for white LED back-light driving.

When LCM is operated over 60℃ ambient temperature, the IAK of the LED back-light should be adjusted to 157mA max



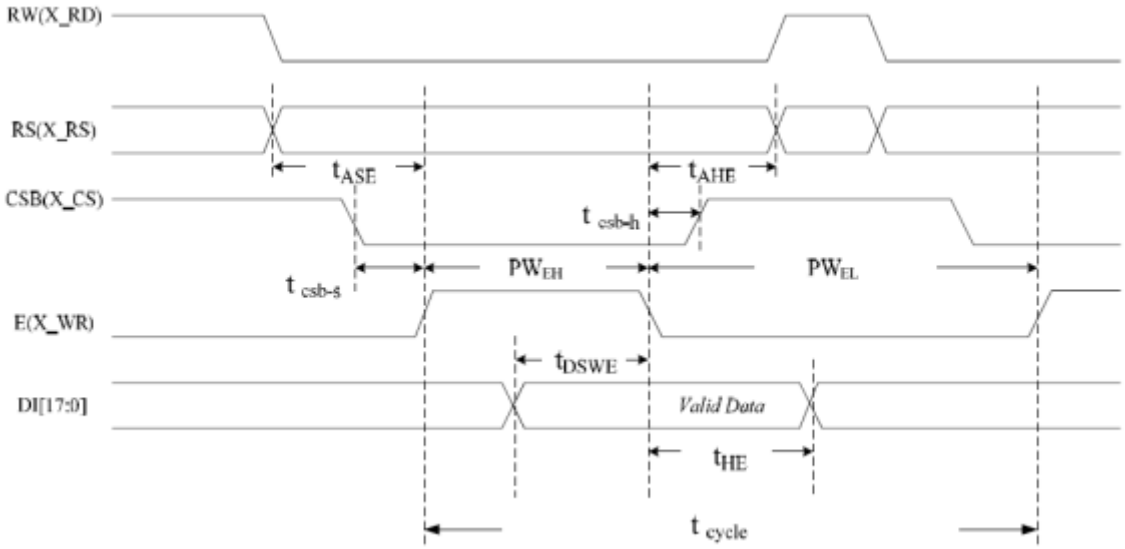
4.3 AC Timing characteristic of the Graphic TFT LCD controller

4.3.1 80 series Timing



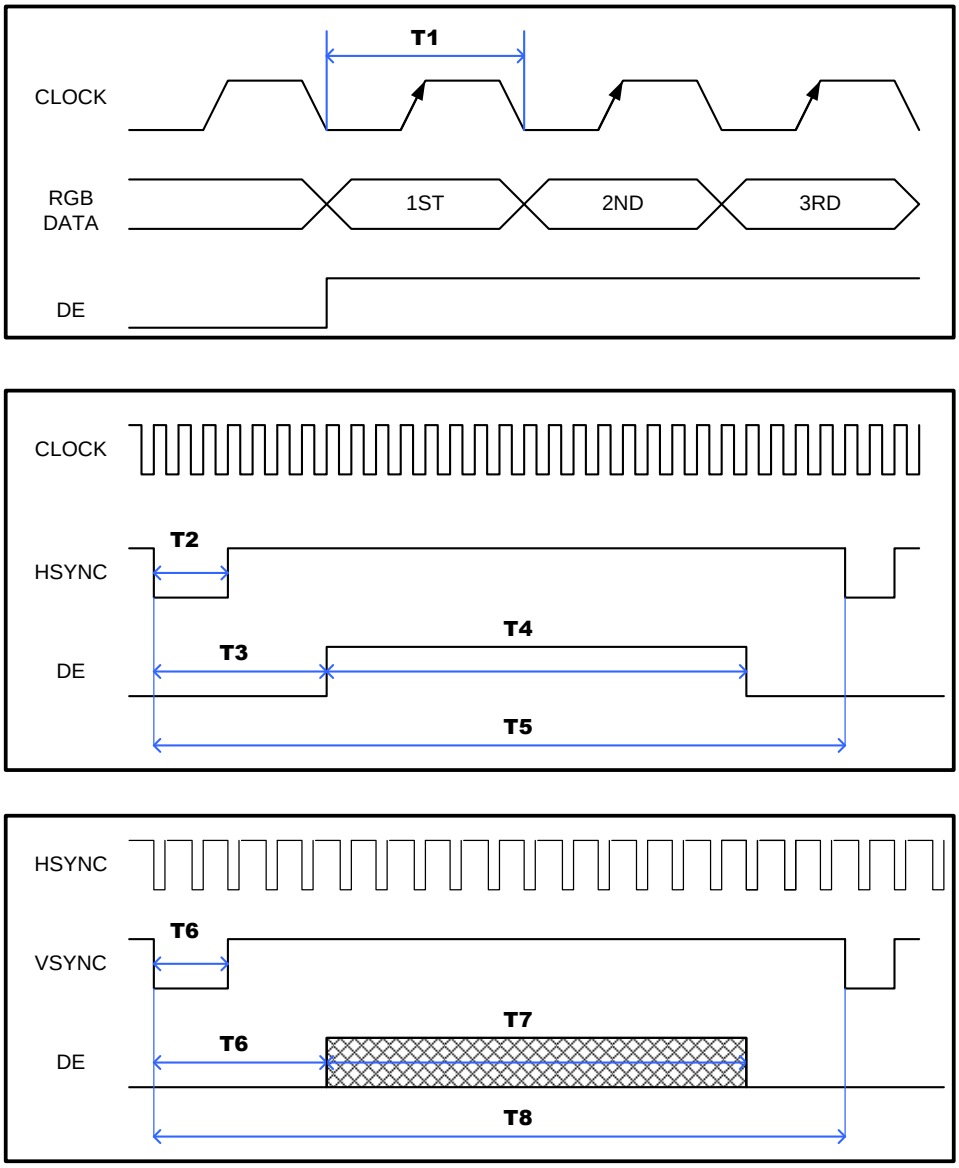
Symbol	Parameter	Min	Typ.	Max	Unit	Remark
t_{cycle}	Enable cycle time	100	200		ns	
PW_{HW}	Enable high-level pulse width	66	70		ns	
PW_{LW}	Enable low-level pulse width	33	130		ns	
t_{AS}	RS setup time	16	25		ns	
t_{AH}	RS hold time	16	45		ns	
t_{DSW}	Write data setup time	50	50		ns	
t_{HWR}	Write data hold time	50	40		ns	
t_{csb-s}	CSB setup time	16	20		ns	
t_{csb-h}	CSB hold time	16	30		ns	

4.3.2 68eries Timing



Symbol	Parameter	Min	Typ.	Max	Unit	Remark
t_{cycle}	Enable cycle time	100	200		ns	
PW_{EH}	Enable high-level pulse width	66	70		ns	
PW_{EL}	Enable low level pulse width	33	130		ns	
t_{ASE}	RS setup time	16	25		ns	
t_{AHE}	RS hold time	16	45		ns	
t_{DSWE}	Write data setup time	50	50		ns	
t_{HE}	Write data hold time	50	40		ns	
t_{csb-s}	CSB setup time	16	20		ns	
t_{csbh}	CSB hold time	16	30		ns	

4.3.3 TTL RGB Timing



ITEM	SYMBOL	MIN	TYP	MAX	UNIT
Clock Frequency	1/T1	5	6	8	MHz
HSYNC Plus Wide	T2	2	4	43	clocks
HSYNC to DE	T3	3	43	43	Clocks
Horizontal Display Period	T4	320	320	320	Clocks
Horizontal total Period	T5	325	371	438	Clocks
VSYNC Plus Wide	T2	2	4	12	Lines
VSYNC to DE	T6	2	12	12	Lines
Vertical Display Period	T7	240	240	240	Lines
Vertical total Period	T8	244	260	289	Lines

5 Optical specification

5.1 Optical characteristic of the LCD

Item		Symbol	Condition	Min.	Typ.	Max.	Unit	Remark
Response Time	Rise Fall	T_r T_f	Θ=0°	--	35	45	ms	Note 1,2,3,5
Contrast ratio		CR	At optimized viewing angle	700	1000	-		Note 1,2,4,5
Viewing Angle	Top Bottom Left Right		CR≧10	70 70 70 70	80 80 80 80	- - - -	deg.	Note1,2, 5,6
Brightness		Y_L	IAK=210mA 25℃	400	500	-	cd/m^2	Note 7
Brightness Uniformity				75	--	--	%	Note 8
Red chromaticity		X_R	Θ=0° Θ=0°	Typ. -0.05	0.638	Typ. +0.05		Note 7 For reference only. These data should be update according the prototype.
		Y_R			0.312			
Green chromaticity		X_G			0.278			
		Y_G			0.538			
Blue chromaticity		X_B			0.147			
		Y_B			0.115			
White chromaticity		X_W			0.312			
		Y_W			0.356			

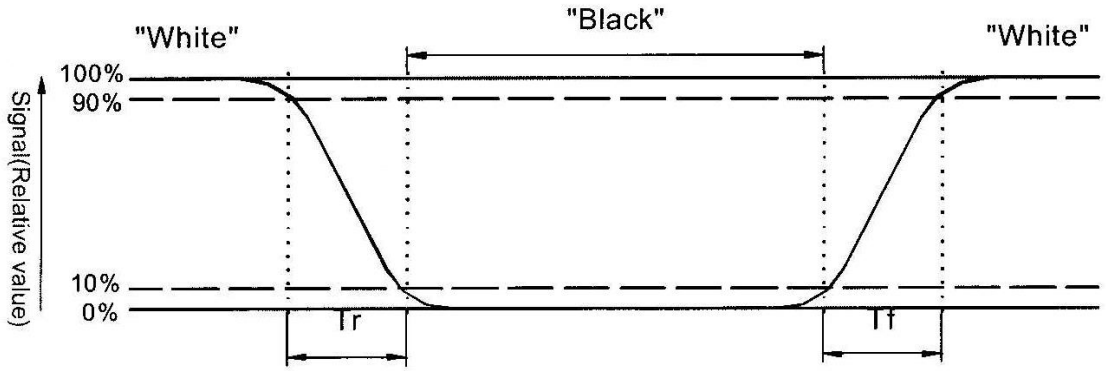
( )For reference only. These data should be update according the prototype.

Note 1: Ambient temperature=25℃,and I_{AK}=210mA.To be measured in the dark room.

Note 2: To be measured on the center area of panel with a viewing cone of 1°by Topcon luminance meter BM-7,after 10 minutes operation.

Note 3.Definition of response time:

The output signals of photo detector are measured when the input signals are changed from “black“ to “white”(falling time) and from”white” to “black” (rising time),respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as below.



Note 4.Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

$$\text{Contrast ratio(CR)} = \frac{\text{Photo detector output when LCD is at ”White” state}}{\text{Photo detector Output when LCD is at “Black” state}}$$

Note 5: White $V_i=V_{i50}$ +1.5V

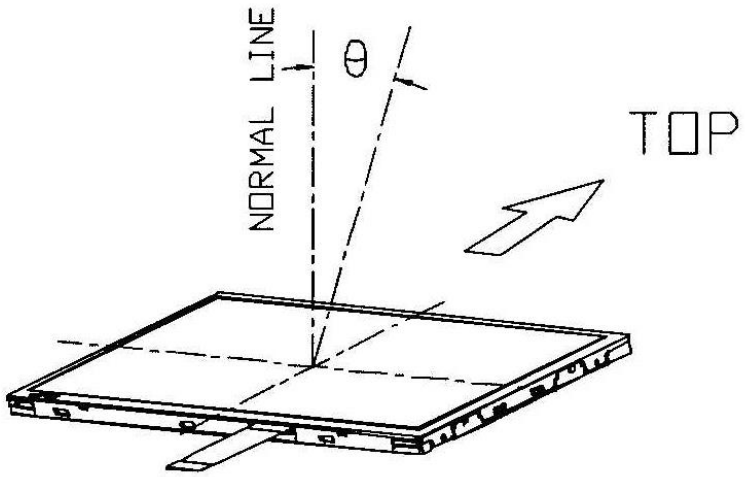
Black $V_i=V_{i50}$ +2.0V

“±”means that the analog input signal swings in phase with V_{COM} signal.

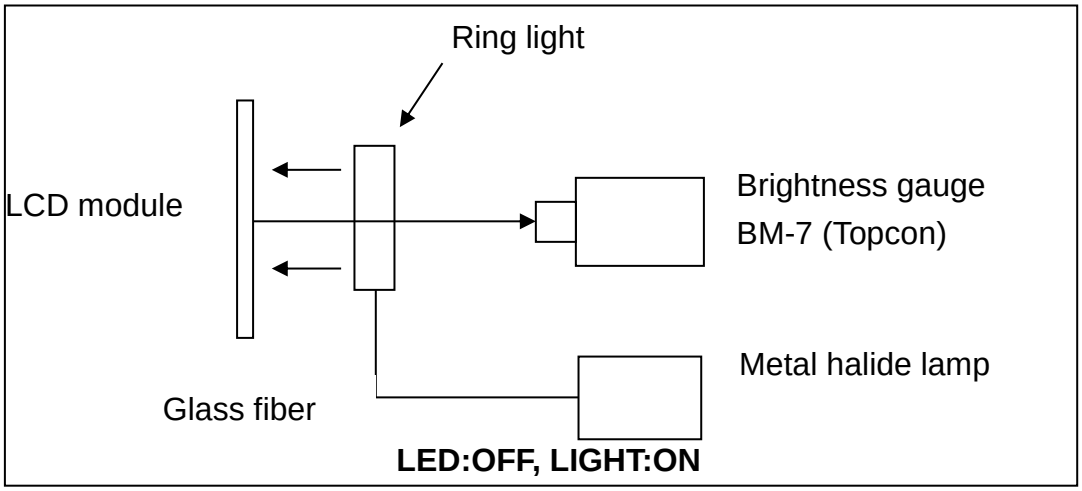
“$\frac{-}{+}$“ means that the analog input signal swings out of phase with V_{COM} signal.

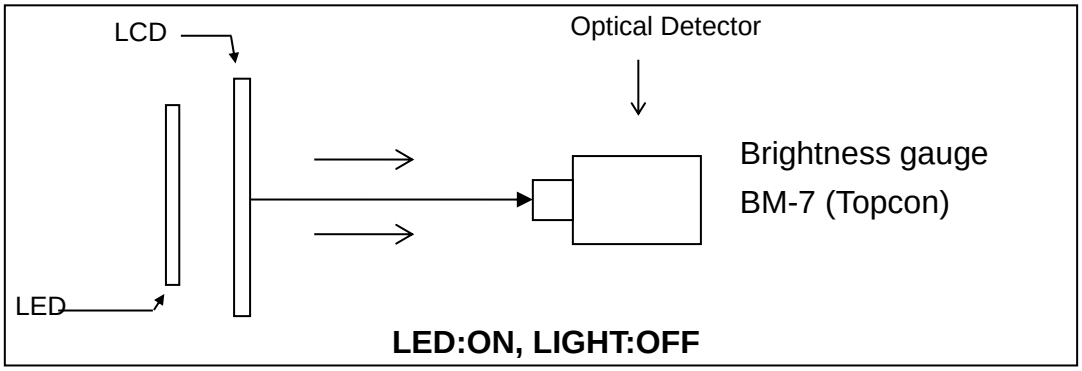
V_{i50} : The analog input voltage when transmission is 50%.The 100% Transmission is defined as the transmission of LCD panel when all the Input terminals of module are electrically opened.

Note 6. Definition of viewing angle, Refer to figure as below.



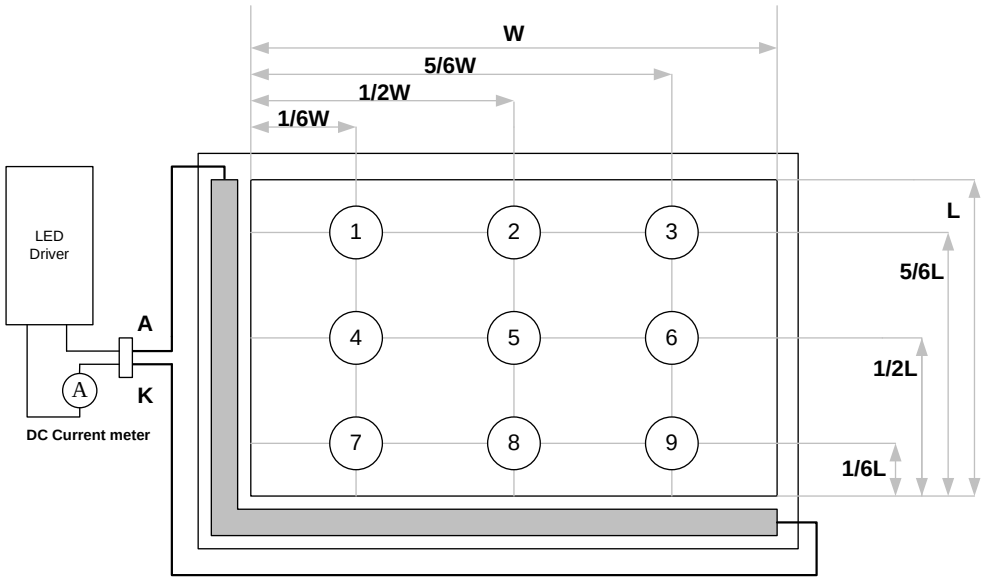
Note 7. Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.





Note 8: The Uniformity definition

(Min Brightness / Max Brightness) x 100%

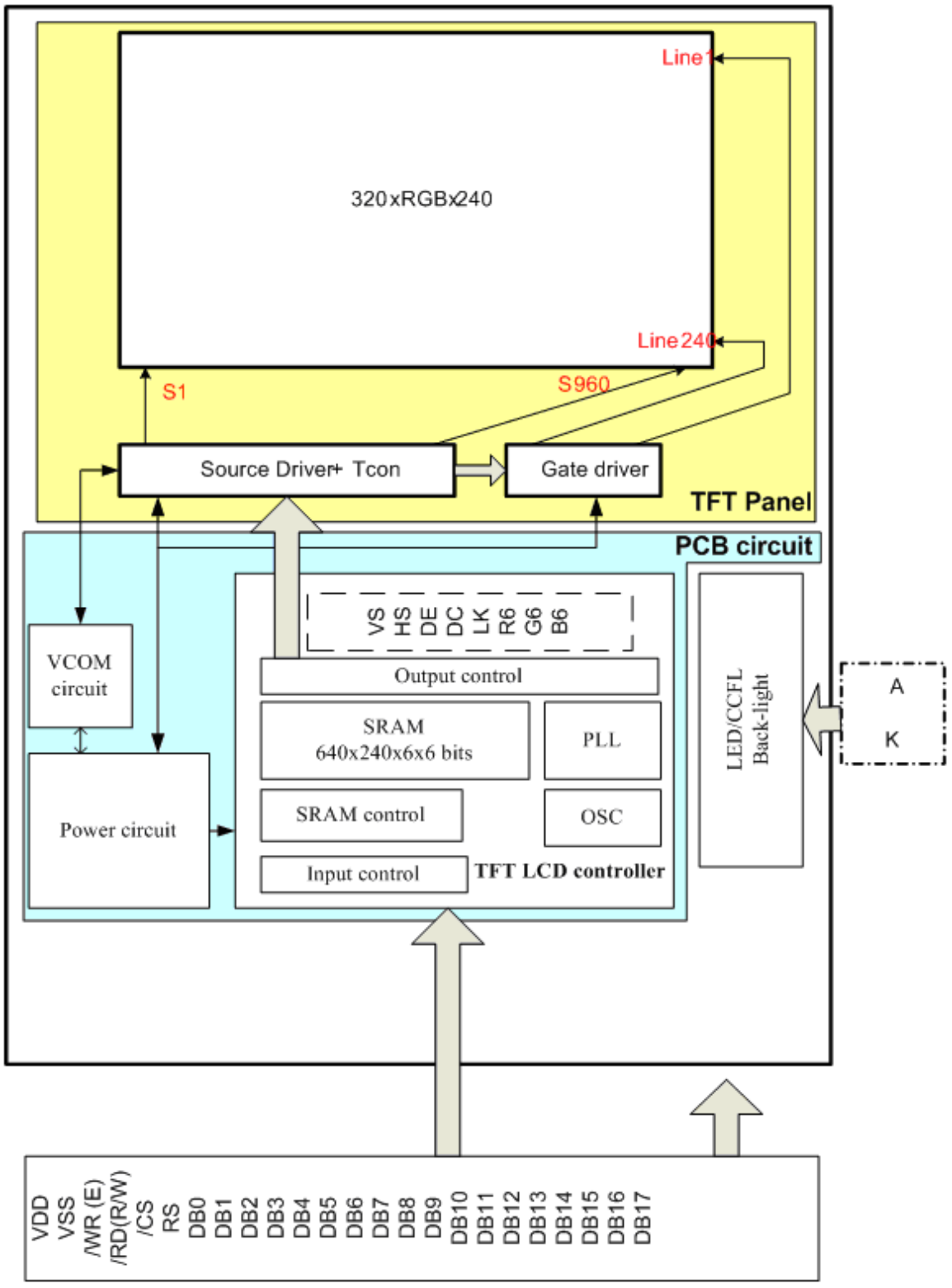


6 Interface specifications

6.1 Driving signals for the TFT panel

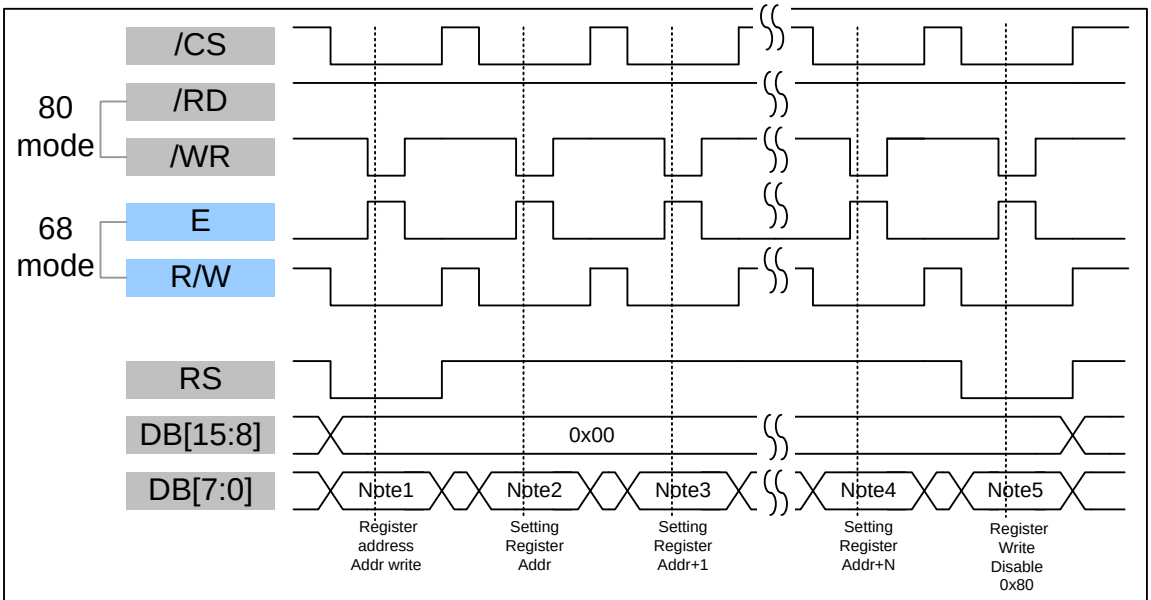
Pin no	Symbol	I/O	Description	Remark
1	/RESET	I	Reset Signal	
2	/WR	I	80 Series: Write Signal 68 Series: R/W Signal	
3	/CS	I	Chip Select Signal	
4	RS	I	Data type selection	
5	RD	II	80 Series: Read signal 68 Series: Enable signal(E)	
6	D0	I/O	Data input/output	
7	D1	I/O		
8	D2	I/O		
9	D3	I/O		
10	D4	I/O		
11	D5	I/O		
12	D6	I/O		
13	D7	I/O		
14	DGND	I	Ground	
15	D8	I/O	Data input/output	
16	D9	I/O		
17	D10	I/O		
18	D11	I/O		
19	D12	I/O		
20	D13	I/O		
21	D14	I/O		
22	D15	I/O		
23	D16	I/O		
24	D17	I/O		
25	VDD	P	Power Supply for Logic	
26	VDD	P		
27	DGND	P	Ground	
28	DGND	P		
29	65K/262K	I	When use 8 or 16 bit MPU interface. The 65k/262k data format can be select. Lo:65K Hi:262K colors When use 9 or 18bit MPU interface. The 262K data can be used only. The 65K/262K pin must set to Hi	
30	DGND	P	Ground	
31	NC		Not use	
32	NC		Not use	
33	NC		Not use	

7 BLOCK DIAGRAM



8 Interface Protocol

8.1.1 16Bit-80/68- Write to Command Register



Note1: DB[7:0] represent the the Register address Addr. DB[15:8] must be 0x00

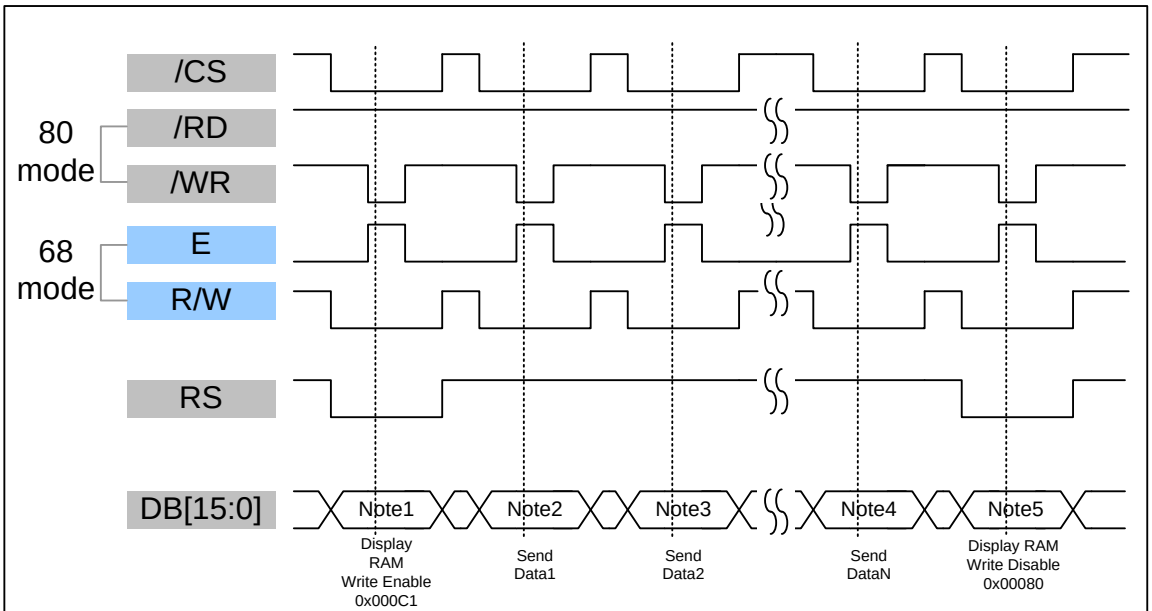
Note2: DB[7:0] represent the the setting value of the Addr. DB[15:8] must be 0x00

Note3: DB[7:0] represent the the setting value of the Addr+1. DB[15:8] must be 0x00

Note4: DB[7:0] represent the the setting value of the Addr+N. DB[15:8] must be 0x00

Note5: DB[7:0] send 0x80 to Disable the Register write. DB[15:8] must be 0x00

8.1.2 16Bit-80/68-Write to Display RAM



Note1: DB[15:0] send 0x000C1 to Enable the Display RAM write.

Note2: DB[15:0] represent the writing Data1 to Display RAM

Note3: DB[15:0] represent the writing Data2 to Display RAM

Note4: DB[15:0] represent the writing DataN to Display RAM

Note5: DB[15:0] send 0x00080 to Disable the Display RAM write.

8.2 Data transfer order Setting

8.2.1 16 bit interface 65K color (Pin29 65K/262K =Low)

DB	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B4	B3	B2	B1	B0

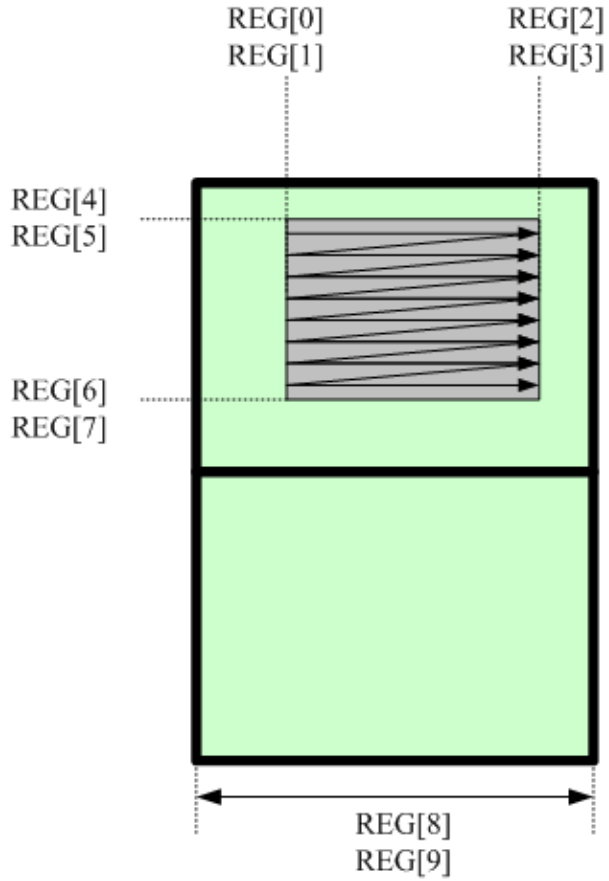
8.2.2 16 bit interface 262K color (Pin29 65K/262K =High)

DB	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1st data	X	X	X	X	X	X	X	X	X	X	X	X	X	X	R5	R4
2nd data	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1	B0

9 Register Depiction

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
00	00	MSB of X-axis start position								
Description	set the horizontals start position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
01	00	LSB of X-axis start position								
Description	set the horizontals start position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
02	01	MSB of X-axis end position								
Description	set the horizontals end position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
03	3F	LSB of X-axis end position								
Description	set the horizontals end position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
04	00	MSB of Y-axis start position								
Description	set the vertical start position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
05	00	LSB of Y-axis start position								
Description	Set the vertical start position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
06	00	MSB of Y-axis end position								
Description	set the vertical end position of display active region									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
07	EF	LSB of Y-axis end position								
Description	Set the vertical end position of display active region									

To simplify the address control of display RAM access, the window area address function allows for writing data only within a window area of display RAM specified by registers REG[00]~REG[07] .
After writing data to the display RAM, the Address counter will be increased within setting window address-range which is specified by
MIN X address (REG[0] & REG[1])
MAX X address (REG[2] & REG[3])
MIN Y address (REG[4] & REG[5])
MAX Y address (REG[6] & REG[7])
Therefore, data can be written consecutively without thinking the data address.



Register Address (Hex)	Default (Hex)	DB7	DB 6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
08	01	X	X	X	X	X	X	_PanelXSize H_Byte[1:0]		
Description	Set the panel X size									
Register Address (Hex)	Default (Hex)	DB7	DB 6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
09	40	_PanelXSize L_Byte[7:0]								
Description	Set the panel X size									

The register REG[08] and REG[09] is use to calculate the RAM address. If you want to use the TFT as Landscape mode (320x240), the REG[08] & RGE[09 must set to 320. If you want to use the TFT as Portrait mode (240x320), the REG[08] & RGE[09] must set to 240.

Register Address (Hex)	Default (Hex)	DB7	DB 6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0A	00	X	X	X	X	X	[17:16] bits of memory write start address			
Description	Memory write start address									
Register Address (Hex)	Default (Hex)	DB7	DB 6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0B	00	[15:8] bits of memory write start address								
Description	Memory write start address									
Register Address (Hex)	Default (Hex)	DB7	DB 6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0C	00	[7:0] bits of memory write start address								
Description	Memory write start address									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x10	0x0D	Bit_SWAP	OUT_TEST	BUS_SEL		Blanking	P/S_SEL	CLK_SEL		
Description	"0x10_Clk_sel[1:0]" : The TFT controller built-in 40Mhz PLL clock. These bits are for select the TFT panel dot clock frequency. 00 : 20Mhz 01: 10Mhz 02: 5 Mhz									
	"0x10_ps_sel[2]" : The TFT controller support parallel and serial RGB interface. These bits are for select the output timing. 0 : serial Panel 1: Parallel panel									
	"0x10_blanking_tmp[3]" 0 : OFF (blanking) 1: ON (normal operation)									
	"0x10_bus_sel[5:4]" : It only for serial Panel 00=R , 01=G , 10=B									
	"0x10_out_test[6]" : Self test 0 : normal operation 1: for test (don't use for normal operation) When set the bit to "1" , the Rout=(Reg 2a[6:0]) Gout=(Reg 2b[6:0]) Bout=(Reg 2c[6:0])									
	"0x10_bit_swap[7]" : 0-normal									
	The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x11	00	X	X	EVEN			_ODD			
Description	" Even line of serial panel data out sequence or data bus order of parallel panel									

	000: RGB 001: RBG 010: GRB 011: GBR 100: BRG 101: BGR Others: reserved Odd line of serial panel data out sequence 000: RGB 001: RBG 010: GRB 011: GBR 100: BRG **101: BGR** Others: reserved **Must Set to 0x05 for AM320240N1**

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x12	00					Hsync_stH_Byte[3:0]				
Description	For TFT output timing adjust: Hsync start position H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x13	00	Hsync_stL_Byte[7:0]								
Description	For TFT output timing adjust: Hsync start position L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x14	00					Hsync_pwH_Byte[3:0]				
Description	For TFT output timing adjust: Hsync pulse width H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x15	10	Hsync_pwL_Byte[7:0]								
Description	For TFT output timing adjust: Hsync pulse width L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x16	00					Hact_stH_Byte[3:0]				
Description	For TFT output timing adjust:									

	DE pulse start position H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x17	38	Hact_stL_Byte[7:0]								
Description	For TFT output timing adjust: DE pulse start position L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x18	01					Hact_pwH_Byte[3:0]				
Description	For TFT output timing adjust: DE pulse width H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x19	40	Hact_pwL_Byte[7:0]								
Description	For TFT output timing adjust: DE pulse width L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									

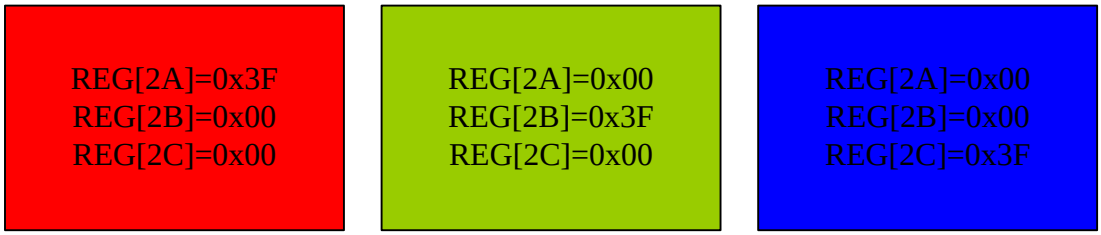
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x1A	01					HtotalH_Byte[3:0]				
Description	For TFT output timing adjust: Hsync total clocks H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x1B	B8	HtotalL_Byte[7:0]								
Description	For TFT output timing adjust: Hsync total clocks H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x1C	00					Vsync_stH_Byte[3:0]				
Description	For TFT output timing adjust: Vsync start position H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x1D	00	Vsync_stL_Byte[7:0]								

Description	For TFT output timing adjust: Vsync start position L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x1E	00					Vsync_pwH_Byte[3:0]				
Description	For TFT output timing adjust: Vsync pulse width H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x1F	08	Vsync_pwL_Byte[7:0]								
Description	For TFT output timing adjust: Vsync pulse width L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x20	00					Vact_stH_Byte[3:0]				
Description	For TFT output timing adjust: Vertical DE pulse start position H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x21	12	Vact_stL_Byte[7:0]								
Description	For TFT output timing adjust: Vertical DE pulse start position L-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x22	00					Vact_pwH_Byte[3:0]				
Description	For TFT output timing adjust: Vertical Active width H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x23	F0	Vact_pwL_Byte[7:0]								
Description	For TFT output timing adjust: Vertical Active width H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x24	01					VtotalH_Byte[3:0]				
Description	For TFT output timing adjust: Vertical total width H-Byte The default setting is suitable for AM320240N1. Don't need to modify it.									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x25	09	VtotalL_Byte[7:0]								
Description	For TFT output timing adjust: Vertical total width L-Byte The default setting is suitable for AM320240N1. Don’t need to modify it.									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
26	00	X	X	X	X	X	[17:16] bits of memory read start address			
Description	Memory read start address									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
27	00	[15:8] bits of memory write start address								
Description	Memory read start address									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
28	00	[7:0] bits of memory write start address								
Description	Memory read start address									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
29	00	[7:1] Reversed								
Description	[0] Load output timing related setting (H sync., V sync. and DE) to take effect									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x2A	00	X	TestPatternRout[6:0]							
Description	When " REG[0x10]_out_test[6]" : Self test =1 ; The Rout data equal to TestPatternRout[6:0]									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x2B	00	X	TestPatternGout[6:0]							
Description	When " REG[0x10]_out_test[6]" : Self test =1 ; The Gout data equal to TestPatternGout[6:0]									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x2C	00	X	TestPatternBout[6:0]							
Description	When " REG[0x10]_out_test[6]" : Self test =1 ; The Bout data equal to TestPatternBout[6:0]									

If you set the " REG[0x10]_out_test[6]" : Self test =1 , the TFT controller will skip the connect of the display RAM. The Output port will send the REG[2A] ,REG[2B],REG[2C] data.



Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
0x2D	00	X	X	X	X	[3]	Rising/falling edge[2]	_rotate [1:0]		
Description	[3] Output pin X_DCON level control ; TFT Power ON/OFF control 0: TFT POWER circuit OFF 1: TFT POWER circuit ON									
	Rising/falling edge[2] : 0: The RGB out put data are on the Rising edge of the DCLK. 1: The RGB out put data are on the Falling edge of the DCLK.									
	_rotate [1:0]: 00 : rotate 0 degree 01 : rotate90 degree 10 : rotate 270 degree 11 : rotate 180 degree									

Register Address (Hex)	Default (Hex)	DB7	DB 6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
30	00	X	X	X	X	X	_H byte H-Offset[3:0]			
Description	Set the Horizontal offset									
Register Address (Hex)	Default (Hex)	DB7	DB 6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
31	00	_L byte H-Offset[7:0]								
Description	Set the Horizontal offset									

Register Address (Hex)	Default (Hex)	DB7	DB 6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
32	00	X	X	X	X	X	_H byte V-Offset[3:0]			
Description	Set the Vertical offset									

Register Address (Hex)	Default (Hex)	DB7	DB 6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
33	00	_L byte V-Offset[7:0]								
Description	Set the Vertical offset									

Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
34	00	[7:4] Reserved					_H byte H-def[3:0]			
Description	[3:0] MSB of image horizontal physical resolution in memory									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
35	40	_L byte H-def[7:0]								
Description	[7:0] LSB of image horizontal physical resolution in memory									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
36	01	[7:4] Reserved					_H byte V-def[3:0]			
Description	[3:0] MSB of image vertical physical resolution in memory									
Register Address (Hex)	Default (Hex)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Remark
37	E0	_L byte V-def[7:0]								
Description	[7:0] LSB of image vertical physical resolution in memory									

The total RAM size is 640x240x18bit. The user can arrange the Horizontal ram size by REG[34],REG[35] and the Vertical ram size by REG[36],REG[37].
EX: 320x480x18bit REG[34]=0x01 , REG[35]=0x40 , REG[36]=0x01 , REG[37]=0xE0
EX: 640x240x18bit. REG[34]=0x02 , REG[35]=0x80 , REG[36]=0x00 , REG[37]=0xF0

10 Application Note:

```
/* Exported types ------------------------------------------------------------*/
typedef     unsigned   char         uint8;
typedef     signed     char         int8;
typedef     unsigned   short        uint16;
typedef     signed     short        int16;
typedef     unsigned long           uint32;
typedef     signed     int          int32;



/*********************************************************************/
/*                    STEP1: Define MCU BUS type                     */
/*********************************************************************/
    #define Mode80      // 8080 MCU   /WR   /RD
   //#define Mode68     // 6800 MCU   R/W   E
/*********************************************************************/
/*                    STEP2: Define BUS wide                         */
/*********************************************************************/
   //#define C80_18B
   //#define C80_16B
   //#define C80_9B
   #define C80_8B
/*********************************************************************/
/*                    STEP3: Define Landscap/Portrait                */
/*********************************************************************/
   #define Landscap
   //#define Portrait
/*********************************************************************/
/*                    STEP4: Define Resolution                       */
/*********************************************************************/
#ifdef Landscap
#define       Resolution_X 320
#define       Resolution_Y 240

#endif

#ifdef Portrait
#define       Resolution_X 240
#define       Resolution_Y 320
#endif
```

```
/*************************************************************/
/*                    STEP5: TFT timing                      */
/*************************************************************/
# define Rising 0<<2     // Don't need to change
# define Falling 1<<2    // Don't need to change


#define LCD_DCLK 10                //Select DCLK Frequency    MHz
                          /*   LCD_DCLK=(40*(0x42)/(0x41))/R10_B10*/
                                        /*5, 6.67, 7.5, 8.57, 10, 12, 15, */
                           //Can be 5 , 6 , 7 , 8 ,10,12 ,15

#define LCD_DCLK_Latch       Rising //Rising: for Rising Edge
                                    //Falling: for Rising Edge

#define H_Sync_Pluse_Wide    10      // Hsync Pluse Wide
#define H_Sync_to_DE          68     // DE horizontal start position
#define H_Sync_total          440       // Horizontal total
#define V_Sync_Pluse_Wide    8// Vsync Pluse Wide
#define V_Sync_to_DE          16     // DE vertical start position
#define V_Sync_total          265       // Vertical   total

//*************************************************************//
/**************Don't need to change the bellow macro**************/

#if LCD_DCLK== 5
   #define R41          1
   #define R42          1
   #define R10_B10   2
#endif

#if LCD_DCLK== 6
   #define R41          3
   #define R42          4
   #define R10_B10   2
#endif

#if LCD_DCLK== 7
   #define R41          4
```

```
   #define R42          3
   #define R10_B10      1
#endif

#if LCD_DCLK== 8
   #define R41          12
   #define R42          10
   #define R10_B10      1
#endif

#if LCD_DCLK== 10
   #define R41          1
   #define R42          2
   #define R10_B10      2
#endif

#if LCD_DCLK== 12
   #define R41          5
   #define R42          6
   #define R10_B10      1
#endif


#if LCD_DCLK== 15
   #define R41          2
   #define R42          3
   #define R10_B10      1
#endif


#define _DisplayRAM_WriteEnable_ 0xc1
#define _DisplayRAM_WriteDisable_ 0x80


typedef struct
{
      uint8    REG_Index;
      uint8    REG_Value;

}FSA506_REG_Setting;
```

```
#ifdef  Landscap

static  FSA506_REG_Setting FSA506_A[] =

{
  {0x40,0x12},
  {0x41,R41},
  {0x42,R42},
  {0x08,(uint8)(Resolution_X>>8)},
  {0x09,(uint8)(Resolution_X)},
  {0x0a,0x00},
  {0x0b,0x00},
  {0x0c,0x00},
  {0x10,0x0C|R10_B10},
  //{0x10,0x0C|0x02},
  {0x11,0x05},
  {0x12,0x00},
  {0x13,0x00},
  {0x14,(uint8)(H_Sync_Pluse_Wide>>8)},
  {0x15,(uint8)(H_Sync_Pluse_Wide)},
  {0x16,(uint8)(H_Sync_to_DE>>8)},
  {0x17,(uint8)(H_Sync_to_DE)},
  {0x18,(uint8)(Resolution_X>>8)},
  {0x19,(uint8)(Resolution_X)},
  {0x1a,(uint8)(H_Sync_total>>8)},
  {0x1b,(uint8)(H_Sync_total)},
  {0x1c,0x00},
  {0x1d,0x00},
  {0x1e,(uint8)(V_Sync_Pluse_Wide>>8)},
  {0x1f,(uint8)(V_Sync_Pluse_Wide)},
  {0x20,(uint8)(V_Sync_to_DE>>8)},
  {0x21,(uint8)(V_Sync_to_DE)},
  {0x22,(uint8)(Resolution_Y>>8)},
  {0x23,(uint8)(Resolution_Y)},
  {0x24,(uint8)(V_Sync_total>>8)},
  {0x25,(uint8)(V_Sync_total)},
  {0x26,0x00},
  {0x27,0x00},
  {0x28,0x00},
```

```
  {0x29,0x01},


  {0x2d,LCD_DCLK_Latch|0x08},
  // [7:4] Reserved
  // [3] Output pin X_DCON level control
  // [2] Output clock inversion        0: Normal 1: Inverse
  // [1:0] Image rotate
//        00: 0°    01: 90°    10: 270° 11: 180°

  {0x30,0x00},
  {0x31,0x00},
  {0x32,0x00},
  {0x33,0x00},
  {0x34,(uint8)(Resolution_X>>8)},
  {0x35,(uint8)(Resolution_X)},
  {0x36,(uint8)((2*Resolution_Y)>>8)},
  {0x37,(uint8)(2*Resolution_Y)},

};
#endif

#ifdef    Portrait

static    FSA506_REG_Setting FSA506_A[] =

{
  {0x40,0x12},
  {0x41,R41},
  {0x42,R42},
  {0x08,(uint8)(Resolution_X>>8)},
  {0x09,(uint8)(Resolution_X)},
  {0x0a,0x00},
  {0x0b,0x00},
  {0x0c,0x00},
  {0x10,0x0C|R10_B10},
  //{0x10,0x0C|0x02},
  {0x11,0x05},
  {0x12,0x00},
  {0x13,0x00},
```

```
  {0x14,(uint8)(H_Sync_Pluse_Wide>>8)},
  {0x15,(uint8)(H_Sync_Pluse_Wide)},
  {0x16,(uint8)(H_Sync_to_DE>>8)},
  {0x17,(uint8)(H_Sync_to_DE)},
  {0x18,(uint8)(Resolution_Y>>8)},
  {0x19,(uint8)(Resolution_Y)},
  {0x1a,(uint8)(H_Sync_total>>8)},
  {0x1b,(uint8)(H_Sync_total)},
  {0x1c,0x00},
  {0x1d,0x00},
  {0x1e,(uint8)(V_Sync_Pluse_Wide>>8)},
  {0x1f,(uint8)(V_Sync_Pluse_Wide)},
  {0x20,(uint8)(V_Sync_to_DE>>8)},
  {0x21,(uint8)(V_Sync_to_DE)},
  {0x22,(uint8)(Resolution_X>>8)},
  {0x23,(uint8)(Resolution_X)},
  {0x24,(uint8)(V_Sync_total>>8)},
  {0x25,(uint8)(V_Sync_total)},
  {0x26,0x00},
  {0x27,0x00},
  {0x28,0x00},
  {0x29,0x01},


  {0x2d,LCD_DCLK_Latch|0x08|0x01},
  // [7:4] Reserved
  // [3] Output pin X_DCON level control
  // [2] Output clock inversion        0: Normal 1: Inverse
  // [1:0] Image rotate
//        00: 0°    01: 90°    10: 270° 11: 180°

  {0x30,0x00},
  {0x31,0x00},
  {0x32,0x00},
  {0x33,0x00},
  {0x34,(uint8)(Resolution_X>>8)},
  {0x35,(uint8)(Resolution_X)},
  {0x36,(uint8)((2*Resolution_Y)>>8)},
  {0x37,(uint8)(2*Resolution_Y)},
```

```
};
#define             NOP()             __asm{NOP}

#endif
/**************Don't need to change the above macro**************/



void AMP506_80Mode_Command_SendAddress(uint8 Addr);
void AMP506_80Mode_Command_SendData(uint8 Data);
void AMP506_80Mode_16Bit_Memory_SendData(uint16 Dat16bit);
void AMP506_Command_Write(uint8 CMD_Address,uint8 CMD_Value);
void Initial_AMP506(void) ;
void AMP506_WindowSet(uint16 S_X,uint16 S_Y,uint16 E_X,uint16 E_Y)    ;
void FD506_DisplayRAM_WriteEnable(void);
void FD506_DisplayRAM_WriteDisable(void);
void GUI_RectangleFill(uint32 x0, uint32 y0, uint32 x1, uint32 y1, uint16 color);
void Full_LCD(uint16 Dat16bit);
void LCD_Pixel(uint16 x , uint16 y , uint16 couleur);

/**************FSA506 Write Registr Address function    ************************/
void AMP506_80Mode_Command_SendAddress(uint8 Addr)
{

   #ifdef Mode68
   uint16 i;
   CLR_nWRL;
   CLR_RS;
   CLR_CS1;
   CLR_nRD;
   DB16OUT(Addr);
   NOP();NOP();
   SET_nWRL;      //Enable
   NOP();NOP();NOP();    NOP();NOP();//NOP(); NOP();NOP();NOP();
   CLR_nWRL;      //Enable
   SET_RS;

   SET_CS1;
   #endif
```

```
   #ifdef Mode80
   SET_nRD;                    //SET_RW
   CLR_RS;
   DB16OUT(Addr); NOP();
   CLR_CS1;
   CLR_nWRL;                   //CLR_E

   NOP();NOP();NOP();
   SET_nWRL;                 //SER_E         // Low to High Latch Data to AMP506 Buffer
   SET_RS;
   SET_CS1;
   #endif


}
/**************FSA506 Write Command Data function    ************************/
void AMP506_80Mode_Command_SendData(uint8 Data)
{
   #ifdef Mode68
   uint16 i;
   CLR_nWRL;     //E
   SET_RS;
   CLR_CS1;
   CLR_nRD;       //W/R
   DB16OUT(Data);
   NOP();NOP();
   SET_nWRL;
   NOP();NOP();NOP();NOP();NOP();//NOP();NOP();NOP();
   CLR_nWRL;     //E nable
   SET_RS;
   SET_CS1;

   #endif

   #ifdef Mode80
   SET_nRD;
   SET_RS;
   DB16OUT(Data); NOP(); // NOP()
```

```
   CLR_CS1;
   CLR_nWRL;

   NOP();NOP();NOP();
   SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
   SET_RS;
   SET_CS1;
   #endif

}
/**************FSA506 Write Data function    *************************/
void AMP506_80Mode_16Bit_Memory_SendData(uint16 Dat16bit)
{


  #ifdef Mode80
   #ifdef C80_16B
   SET_nRD;
   SET_RS;
   DB16OUT(Dat16bit);NOP();
   CLR_CS1;

   CLR_nWRL;

   NOP(); NOP();    NOP();

   SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
   SET_CS1;

   #endif

   #ifdef C80_8B
   DB16OUT(Dat16bit>>8);NOP();NOP();
   SET_nRD;
   SET_RS;

   CLR_CS1;
   CLR_nWRL;

   NOP(); NOP();    NOP();
```

```
SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
SET_CS1;

//Delay_uS(1);
DB16OUT(Dat16bit);NOP(); NOP();
SET_nRD;
SET_RS;

CLR_CS1;
CLR_nWRL;
NOP(); NOP();    NOP();
SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
SET_CS1;

#endif
//Delay_uS(1);



#ifdef C80_18B

uint32 k=0;
uint16 R_temp,G_temp,B_temp;

R_temp=((0xf800&Dat16bit)>>11);
G_temp=((0x07e0&Dat16bit)>>5);
B_temp=((0x001f&Dat16bit));

k|=((R_temp<<1)<<12);    //+G_temp+B_temp;
k|=(G_temp<<6);
k|=(B_temp<<1);

FIO1MASK=0xFFE0FFFF;                    // FIOMASK 只可寫 P1.20~P1.16
FIO1PIN=k;                        //  將 Address A20~A16 寫入 P1.20~P1.16
FIO1MASK=0x00;



SET_nRD;
SET_RS;
DB16OUT(k);NOP();
CLR_CS1;
```

```
  CLR_nWRL;

   NOP(); NOP();    NOP();


  SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
  SET_CS1;

  #endif

  #ifdef C80_9B

  uint32 k=0;
  uint16 R_temp,G_temp,B_temp;

  R_temp=((0xf800&Dat16bit)>>11);
  G_temp=((0x07e0&Dat16bit)>>5);
  B_temp=((0x001f&Dat16bit));

  k|=((R_temp<<1)<<12);    //+G_temp+B_temp;
  k|=(G_temp<<6);
  k|=(B_temp<<1);



  SET_nRD;
  SET_RS;
  CLR_CS1;
  CLR_nWRL;

  DB16OUT(((k&0x3FE00)>>9));

  SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
  DB16OUT((k&0x1FF)); NOP();
  SET_CS1;
 // Delay_uS(1);
  SET_nRD;
  SET_RS;
  CLR_CS1;
  CLR_nWRL;
```

```
    NOP(); NOP();    NOP();

    SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
    SET_CS1;

    #endif
  #endif


#ifdef Mode68
    #ifdef C80_16B
    uint16 i;
    NOP();NOP();

    CLR_nWRL;    //E=0
    SET_RS;
    CLR_CS1;
    CLR_nRD;       // W/R=0

    DB16OUT(Dat16bit);

    SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
    NOP();NOP();NOP();NOP();//NOP();NOP();NOP();NOP();
    CLR_nWRL;                          // Low to High Latch Data to AMP506 Buffer
    SET_CS1;
    #endif


    #ifdef C80_8B
    uint16 i;
    //for (i=0;i<16;i++);
    NOP();NOP();
    CLR_nWRL;    //E=0
    SET_RS;
    CLR_CS1;
    CLR_nRD;       // W/R=0

    DB16OUT(Dat16bit>>8);
```

```
SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
NOP();NOP();NOP();NOP();//NOP();NOP();NOP();NOP();
CLR_nWRL;                          // Low to High Latch Data to AMP506 Buffer
SET_CS1;

CLR_nWRL;    //E=0
SET_RS;
CLR_CS1;
CLR_nRD;       // W/R=0

DB16OUT(Dat16bit);

SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
NOP();NOP();NOP();NOP();//NOP();NOP();NOP();NOP();
CLR_nWRL;                          // Low to High Latch Data to AMP506 Buffer
SET_CS1;

#endif
//Delay_uS(1);



#ifdef C80_18B

uint32 k=0;
uint16 R_temp,G_temp,B_temp;
uint16 i;
NOP();NOP();

R_temp=((0xf800&Dat16bit)>>11);
G_temp=((0x07e0&Dat16bit)>>5);
B_temp=((0x001f&Dat16bit));

k|=((R_temp<<1)<<12);    //+G_temp+B_temp;
k|=(G_temp<<6);
k|=(B_temp<<1);

FIO1MASK=0xFFE0FFFF;                    // FIOMASK  只可寫 P1.20~P1.16
FIO1PIN=k;                    //  將 Address A20~A16 寫入 P1.20~P1.16
FIO1MASK=0x00;
```

```
CLR_nWRL;    //E=0
SET_RS;
CLR_CS1;
CLR_nRD;      // W/R=0

DB16OUT(k);

SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
NOP();NOP();NOP();NOP();NOP();//NOP();NOP();NOP();
CLR_nWRL;                          // Low to High Latch Data to AMP506 Buffer
SET_CS1;

#endif

#ifdef C80_9B

uint32 k=0;
uint16 R_temp,G_temp,B_temp;
uint16 i;
//for (i=0;i<16;i++);
NOP();NOP();
R_temp=((0xf800&Dat16bit)>>11);
G_temp=((0x07e0&Dat16bit)>>5);
B_temp=((0x001f&Dat16bit));

k|=((R_temp<<1)<<12);    //+G_temp+B_temp;
k|=(G_temp<<6);
k|=(B_temp<<1);



CLR_nWRL;    //E=0
SET_RS;
CLR_CS1;
CLR_nRD;      // W/R=0

DB16OUT(((k&0x3FE00)>>9));

SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
```

```
   NOP();NOP();NOP();NOP();//NOP();NOP();NOP();NOP();
   CLR_nWRL;                          // Low to High Latch Data to AMP506 Buffer
   SET_CS1;

  // Delay_uS(1);
   CLR_nWRL;    //E=0
   SET_RS;
   CLR_CS1;
   CLR_nRD;       // W/R=0

   DB16OUT((k&0x1FF));

   SET_nWRL;                          // Low to High Latch Data to AMP506 Buffer
   NOP();NOP();NOP();NOP();//NOP();NOP();NOP();NOP();
   CLR_nWRL;                          // Low to High Latch Data to AMP506 Buffer
   SET_CS1;

   #endif
  #endif


}

/**************FSA506 Write Command function    *************************/
void AMP506_Command_Write(uint8 CMD_Address,uint8 CMD_Value)
{
   AMP506_80Mode_Command_SendAddress(CMD_Address);
   AMP506_80Mode_Command_SendData(CMD_Value);
}


/**************FSA506 Initial function    *************************/

void Initial_AMP506(void)              //

{           uint8 i;


       for(i=0;i < (sizeof(FSA506_A) / sizeof (FSA506_A[0]));i++)
```

```
    {
        AMP506_Command_Write(FSA506_A[i].REG_Index , FSA506_A[i].REG_Value);
    }
}

/**************FSA506 Set Start & End area function    ************************/
void AMP506_WindowSet(uint16 S_X,uint16 S_Y,uint16 E_X,uint16 E_Y)

{
        AMP506_80Mode_Command_SendAddress(0x00);

        AMP506_80Mode_Command_SendData((S_X)>>8);
        AMP506_80Mode_Command_SendData(S_X);

        AMP506_80Mode_Command_SendData((E_X-1)>>8);
        AMP506_80Mode_Command_SendData(E_X-1);

        AMP506_80Mode_Command_SendData(S_Y>>8);
        AMP506_80Mode_Command_SendData(S_Y);

        AMP506_80Mode_Command_SendData((E_Y-1)>>8);
        AMP506_80Mode_Command_SendData(E_Y-1);

}

//*****************************************************************************
//                          Enable Display RAM Write
//*****************************************************************************

void FD506_DisplayRAM_WriteEnable(void)
{
        AMP506_80Mode_Command_SendAddress(_DisplayRAM_WriteEnable_);

}
```

```
//*****************************************************************************
//                          Disable Display RAM Write
//*****************************************************************************

void FD506_DisplayRAM_WriteDisable(void)
{

        AMP506_80Mode_Command_SendAddress(_DisplayRAM_WriteDisable_);

}

/**************FSA506 Set Start & End area function    ************************/
void GUI_RectangleFill(uint32 x0, uint32 y0, uint32 x1, uint32 y1, uint16 color)
{
    uint32 k,l;


   AMP506_WindowSet(x0,y0,x1,y1);
   FD506_DisplayRAM_WriteEnable();
  for(k=y0;k<y1;k++)

    {
      for(l=x0;l<x1;l++)
       {
            AMP506_80Mode_16Bit_Memory_SendData(color);
        }
    }
   FD506_DisplayRAM_WriteDisable();

}
/**************Full Display function    ************************/
void Full_LCD(uint16 Dat16bit)
{

   GUI_RectangleFill(0,0,Resolution_X,Resolution_Y,Dat16bit);

}

void LCD_Pixel(uint16 x , uint16 y , uint16 couleur)
{
```

```
    uint8 hiByte, lowByte;



    AMP506_80Mode_Command_SendAddress(0x00);
    AMP506_80Mode_Command_SendData((x)>>8);
    AMP506_80Mode_Command_SendData(x);
    AMP506_80Mode_Command_SendData((x)>>8);
    AMP506_80Mode_Command_SendData(x);
    AMP506_80Mode_Command_SendData(y>>8);
    AMP506_80Mode_Command_SendData(y);
    AMP506_80Mode_Command_SendData((y)>>8);
    AMP506_80Mode_Command_SendData(y);

    FD506_DisplayRAM_WriteEnable();
    AMP506_80Mode_16Bit_Memory_SendData(couleur);
    FD506_DisplayRAM_WriteDisable();

}

void main(void)
{

      Initial_AMP506();
      Full_LCD(0xf800);
      Full_LCD(0x07e0);
      Full_LCD(0x001f);

}
```

The TFT LCD controller default value is for AM320240NS already. So we can start to write our data in a few steps:

Target: To write a 640x240 data to Display RAM and scroll the display data by change the Horizontal offset register.

10.1 Step 1: Make sure the interface Protocol.

10.2 Step 2: Define the Horizontal ram seize = 640 and Vertical ram size =240

640x240x18bit. REG[34]=0x02 , REG[35]=0x80 , REG[36]=0x00 , REG[37]=0xF0

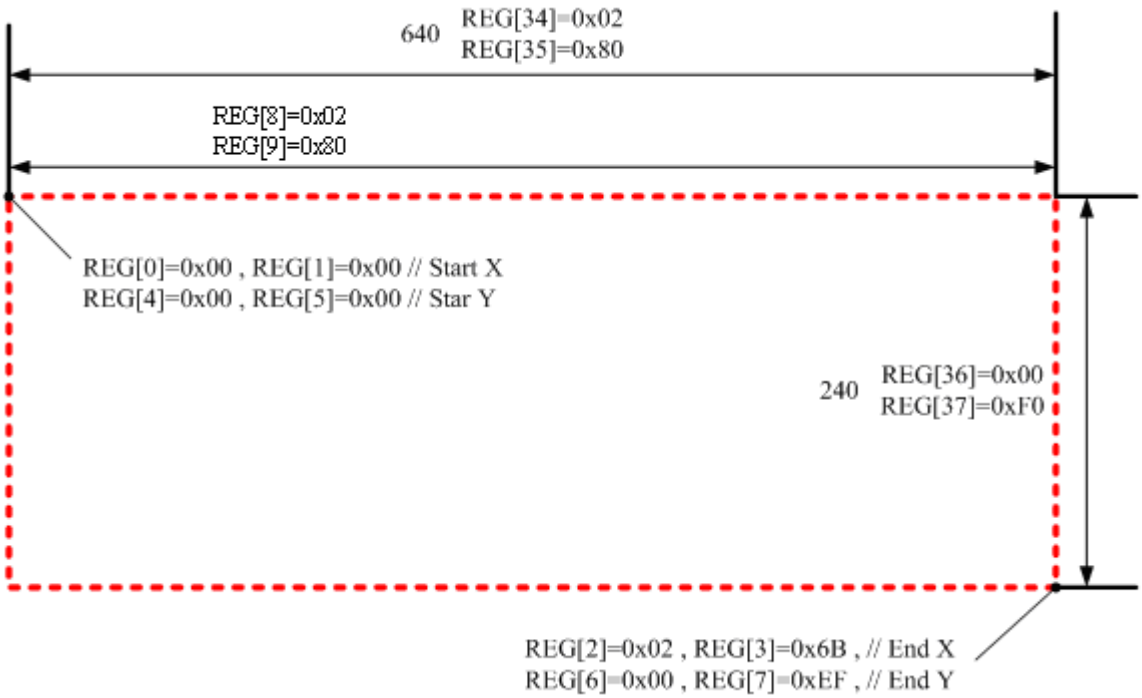
10.3 Step 3: Define the Panel X Size = 320

REG[8]=0x02 , REG[9]=0x80

10.4 Step4: Define the Write window. Start=(0,0) End=(619,239)

REG[0]=0x00 , REG[1]=0x00 , REG[2]=0x02 , REG[3]=0x6B , // Start X , End X

REG[4]=0x00 , REG[5]=0x00 , REG[6]=0x00 , REG[7]=0xEF , // Star Y ,End Y



10.5 Step5: Write the 640x240x18 bit data consecutively

10.6 Step6: The display will show the following image.

10.7 Step7: Change the Horizontal offset to switch or scroll the display data. Set the Horizontal offset = 160 , REG[30]=00 REG[31]=A0 . You will see

10.8 Step8: Change the Horizontal offset to switch or scroll the display data. Set the Horizontal offset = 320 , REG[30]=01 REG[31]=40 . You will see

DISPLAYED COLOR AND INPUT DATA

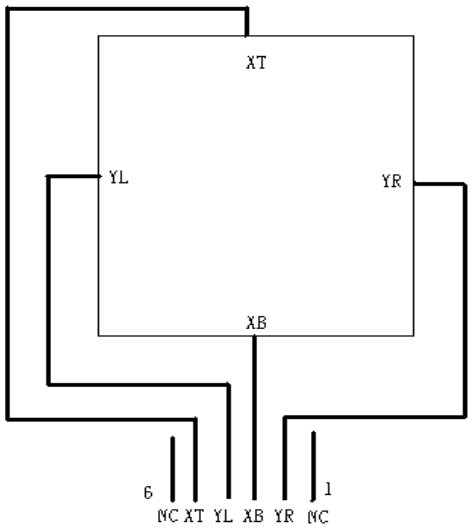
	Color & Gray Scale	DATA SIGNAL																	
		R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	B3	B2	B1	B0
Basic Color	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(63)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green(63)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Blue(63)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Red	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red(2)	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Red(31)	0	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Red(62)	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(63)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
Green	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
	Green(2)	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Green(31)	0	0	0	0	0	0	0	1	1	1	1	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Green(62)	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	0
	Green(63)	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
Blue	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	Blue(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Blue(31)	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1
	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:	:
	Blue(62)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0
	Blue(63)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

11 Touch Panel Electrical Specification

Parameter	Condition	Standard Value
Terminal Resistance	X Axis	160 ~ 640 Ω
	Y Axis	200 ~ 900 Ω
Insulating Resistance	DC 25 V	More than 10MΩ
Linearity	--	±1.5 %
Notes life by Pen		100,000 times(min)
Input life by finger		1,000,000 times (min)

Interface

No.	Symbol	Function
1	NC	No connection
2	YR	Touch Panel Right Signal
3	XB	Touch Panel Bottom Signal
4	YL	Touch Panel Left Signal
5	XT	Touch Panel Top Signal
6	NC	No connection



12 Reliability Test Conditions

Test Item	Test Conditions	Note
High Temperature Operation	70±3°C , t=240 hrs	
Low Temperature Operation	-20±3°C , t=240 hrs	
High Temperature Storage	80±3°C , t=240 hrs	1,2
Low Temperature Storage	-30±3°C , t=240 hrs	1,2
Thermal Shock Test	-20 C ~ 25 C ~ 70 C 30 min. 5 min. 30 min. (1 cycle) Total 5 cycle	1,2
Humidity Test	40 C, Humidity 90%, 96 hrs	1,2
Vibration Test (Packing)	Sweep frequency : 10 ~ 55 ~ 10 Hz/1min Amplitude : 0.75mm Test direction : X.Y.Z/3 axis Duration : 30min/each axis	2

Note 1 : Condensation of water is not permitted on the module.

Note 2 : The module should be inspected after 1 hour storage in normal conditions (15-35°C , 45-65%RH).

Note 3 : The module shouldn't be tested more than one condition, and all the test conditions are independent.

Note 4 : All the reliability tests should be done without protective film on the module.

Definitions of life end point:

Current drain should be smaller than the specific value.

Function of the module should be maintained.

Appearance and display quality should not have degraded noticeably.

Contrast ratio should be greater than 50% of the initial value.

13 USE PRECAUTIONS

13.1 HANDLING PRECAUTIONS

(1) An LCD module is a fragile item and should not be subjected to strong mechanical shocks.

(2) Avoid applying pressure to the module surface. This will distort the glass and cause a change in colour.

(3) Under no circumstances should the position of the bezel tabs or their shape be modified.

(4) Do not modify the display PCB in either shape or positioning of components.

(5) Do not modify or move location of the zebra or heat seal connectors.

(6) The device should only be soldered to during interfacing. Modification to other areas of the board should not be carried out.

(7) In the event of LCD breakage and resultant leakage of fluid do not inhale, ingest or make contact with the skin. If contact is made rinse immediately.

(8) When cleaning the module use a soft damp cloth with a mild solvent, such as Isopropyl or Ethyl alcohol. The use of water, ketone or aromatic is not permitted.

(9) Prior to initial power up input signals should not be applied.

(10) Protect the module against static electricity and observe appropriate anti-static precautions.

13.2 Installing precautions

1) The PCB has many ICs that may be damaged easily by static electricity. To prevent breaking by static electricity from the human body and clothing, earth the human body properly using the high resistance and discharge static electricity during the operation. In this case, however, the resistance value should be approx. 1MΩ and the resistance should be placed near the human body rather than the ground surface. When the indoor space is dry, static electricity may occur easily so be careful. We recommend the indoor space should be kept with humidity of 60% or more. When a soldering iron or other similar tool is used for assembly, be sure to earth it.
2) When installing the module and ICs, do not bend or twist them. Failure to do so may crack LC element and cause circuit failure.
3) To protect LC element, especially polarizing plate, use a transparent protective plate (e.g., acrylic plate, glass etc) for the product case.

4) Do not use an adhesive like a both-side adhesive tape to make LCD surface (polarizing plate) and product case stick together. Failure to do so may cause the polarizing plate to peel off.

13.3 Storage precautions

1) Avoid a high temperature and humidity area. Keep the temperature between 0°C and 35°C and also the humidity under 60%.
2) Choose the dark spaces where the product is not exposed to direct sunlight or fluorescent light.
3) Store the products as they are put in the boxes provided from us or in the same conditions as we recommend.

13.4 Operating precautions

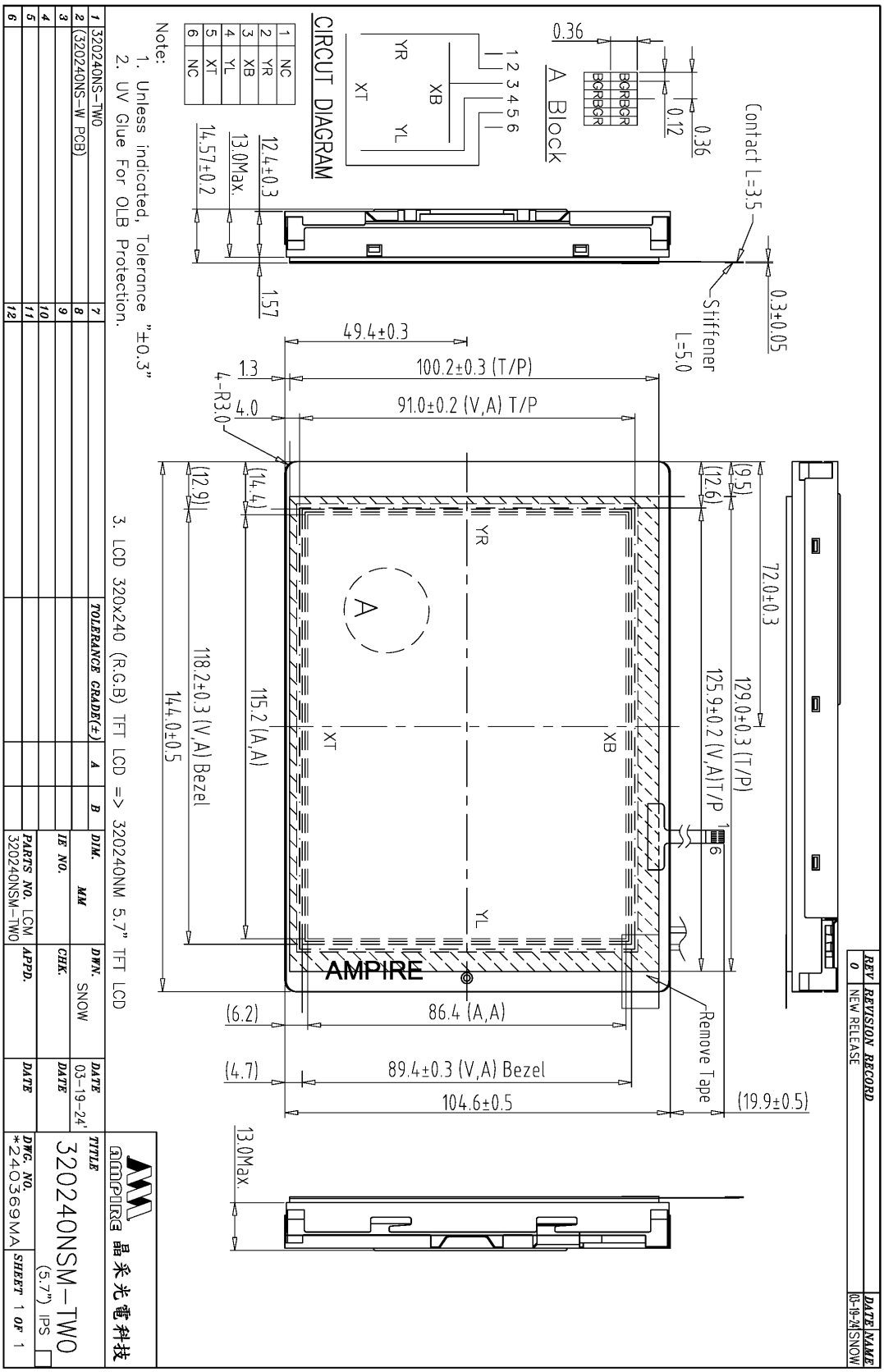
1) Do not boost the applied drive voltage abnormally. Failure to do so may break ICs. When applying power voltage, check the electrical features beforehand and be careful. Always turn off the power to the LC module controller before removing or inserting the LC module input connector. If the input connector is removed or inserted while the power is turned on, the LC module internal circuit may break.
2) The display response may be late if the operating temperature is under the normal standard, and the display may be out of order if it is above the normal standard. But this is not a failure; this will be restored if it is within the normal standard.
3) The LCD contrast varies depending on the visual angle, ambient temperature, power voltage etc. Obtain the optimum contrast by adjusting the LC dive voltage.
4) When carrying out the test, do not take the module out of the low-temperature space suddenly. Failure to do so will cause the module condensing, leading to malfunctions.
5) Make certain that each signal noise level is within the standard (L level: 0.2Vdd or less and H level: 0.8Vdd or more) even if the module has functioned properly. If it is beyond the standard, the module may often malfunction. In addition, always connect the module when making noise level measurements.
6) The CMOS ICs are incorporated in the module and the pull-up and pull-down function is not adopted for the input so avoid putting the input signal open while the power is ON.

7) The characteristic of the semiconductor element changes when it is exposed to light emissions, therefore ICs on the LCD may malfunction if they receive light emissions. To prevent these malfunctions, design and assemble ICs so that they are shielded from light emissions.
8) Crosstalk occurs because of characteristics of the LCD. In general, crosstalk occurs when the regularized display is maintained. Also, crosstalk is affected by the LC drive voltage. Design the contents of the display, considering crosstalk.

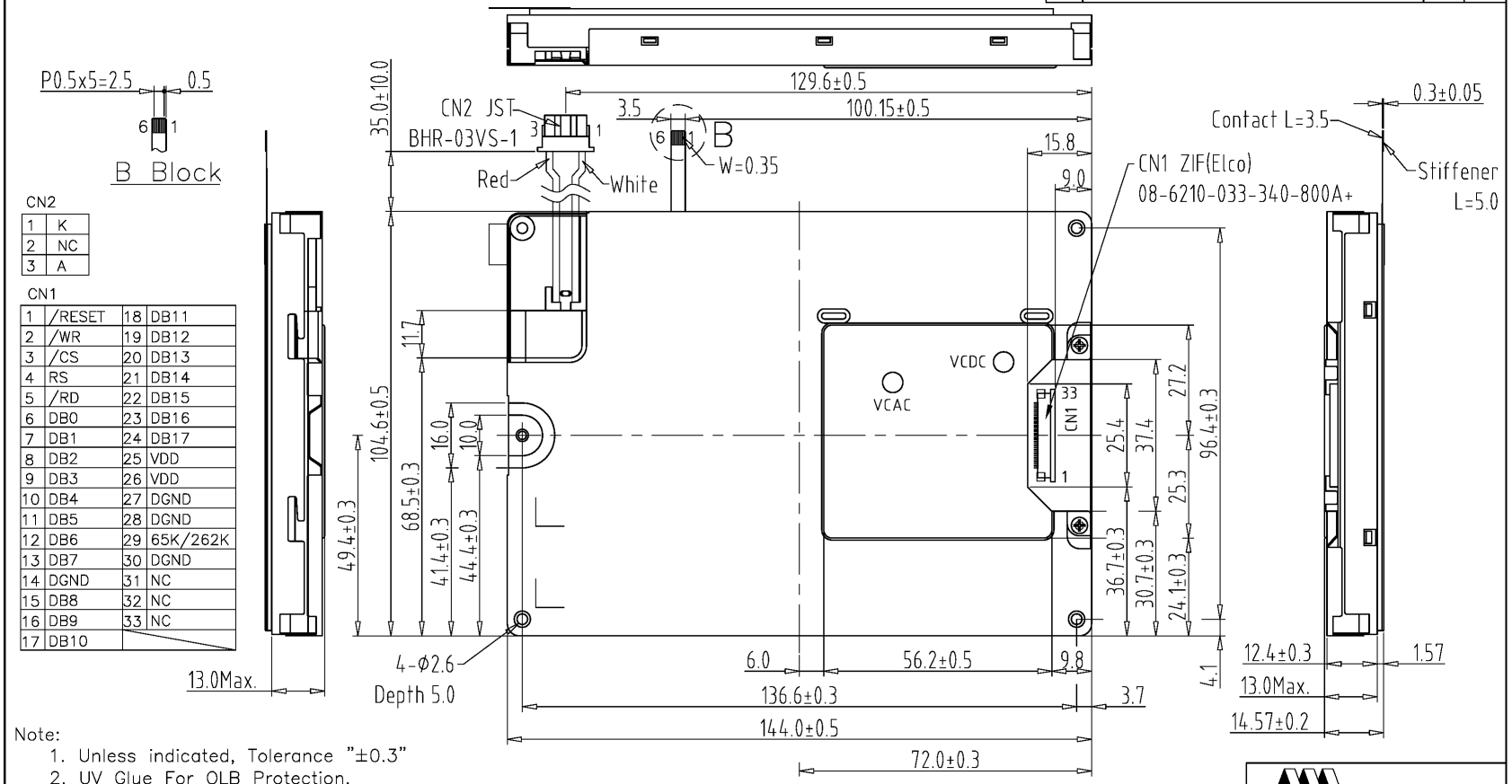
13.5 Other

1) Do not disassemble or take the LC module into pieces. The LC modules once disassembled or taken into pieces are not the guarantee articles.
2) Do not keep the LCD at the same display pattern continually. The residual image will happen and it will damage the LCD. Please use screen saver
3) AMIPRE will provide one year warranty for all products and three months warrantee for all repairing products.

14 OUTLINE DIMENSION



REV	REVISION RECORD	DATE	NAME
0	NEW RELEASE	03-19-24	SNOW



Note:
1. Unless indicated, Tolerance "±0.3"
2. UV Glue For OLB Protection.
3. LCD 320x240 (R.G.B) TFT LCD => 320240NM 5.7" TFT LCD

				TOLERANCE GRADE(±)	A	B
1	320240NS-TW0	7				
2	(320240NS-W PCB)	8				
3		9				
4		10				
5		11				
6		12				

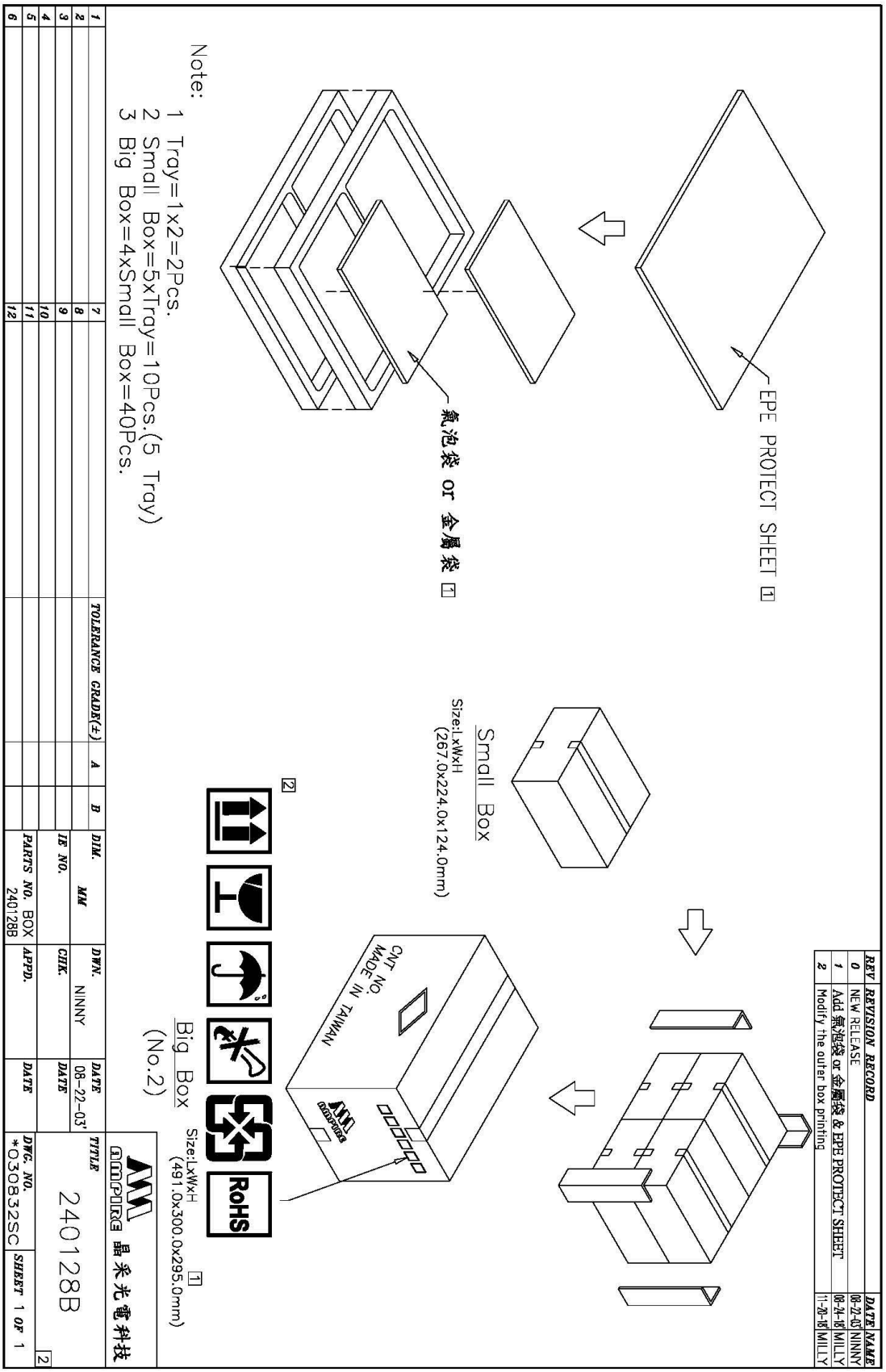
DIM. MM	DWN. SNOW	DATE 03-19-24'
IE NO.	CHK.	DATE
PARTS NO. LCM-1 320240NSM-TW0	APPD.	DATE

晶采光電科技

TITLE: 320240NSM-TW0 (5.7") IPS

DWG. NO. *240370MA SHEET 1 OF 1

15 Packing


REV. REVISION RECORD DATE NAME
0 NEW RELEASE 08-22-03 NINNY
1 Add 氣泡袋 or 金屬袋 & EPE PROTECT SHEET 08-24-18 MILLY
2 Modify the outer box printing 11-28-18 MILLY
EPE PROTECT SHEET 1
氣泡袋 or 金屬袋 1
Small Box
Size:LxWxH
(267.0x224.0x124.0mm)
2
Big Box
(No.2)
Size:LxWxH
(491.0x300.0x295.0mm) 1
RoHS
Note:
1 Tray=1x2=2Pcs.
2 Small Box=5xTray=10Pcs.(5 Tray)
3 Big Box=4xSmall Box=40Pcs.
TOLERANCE GRADE(±) A B DIM. MM
IB NO.
PARTS NO. BOX 240128B
DWN. NINNY DATE 08-22-03'
CHK. DATE
APPD. DATE
TITLE 240128B
DWG. NO. *0308325C
SHEET 1 OF 1
2